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Http://www.ledtech.com.tw

SPECIFICATION

PART NO.: LT1831F-91

5.0mm ROUND FLASHING LED LAMP





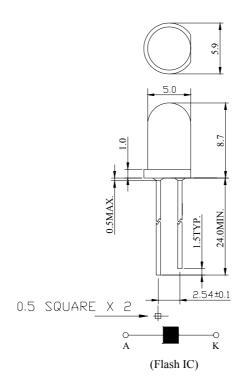
Approved by	Checked by	Prepared by
Tung	Yang	Min Bao

Description

This flashing lamp is made with GaAsP/GaP yellow chip and yellow diffused epoxy resin.

Features

- * BUILT-IN OSCILLATOR AND RESISTOR
- * HIGH LIGHT OUTPUT
- * LOW POWER CONSUMPTION
- * RELIABLE AND RUGGED



Notes:

- 1. All dimensions are in mm.
- 2. Tolerance is \pm 0.25mm unless otherwise noted.

Description

Part No.	LED Chip		Lens Color	
	Material	Emitting Color	Lens Color	
LT1831F-91	GaAsP/GaP	Yellow	Yellow diffused	

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LT1831F-91

Absolute Maximum Ratings at Ta=25

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	225	mW
Peak Reverse Voltage	VR	0.4	V
Operating Temperature Range	Topr	-40 to +85	
Storage Temperature Range	Tstg	-40 to +100	
Soldering Temperature(1.6mm from body)	Tsol	r and B	for 5 sec. For 3 sec.

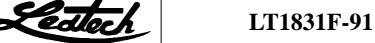
Electrical and Optical Characteristics:

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	Iv	Vf=5V	9.0	20.0		mcd
Applied Voltage	Vf		3.0		5.0	V
Flashing Frequency	f	Vf=5V		2.4		Hz
Peak Wavelength	λр	Vf=5V		585		nm
Dominant Wavelength	λd	Vf=5V		590		nm
Viewing Angle	2 1/2	Vf=5V		35		deg
Spectrum Line Halfwidth	Δλ	Vf=5V		35		nm

Notes:1. The datas tested by IS tester.

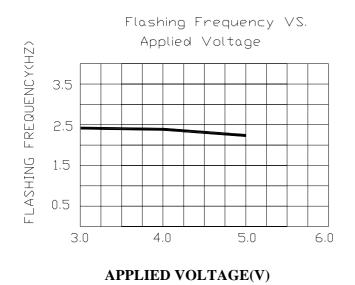
2. Customer's special requirements are also welcome.

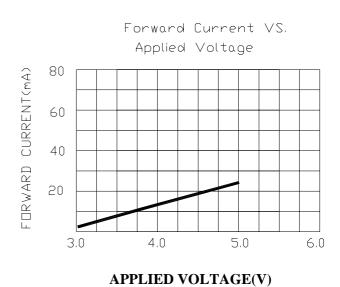
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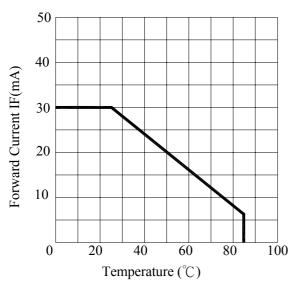


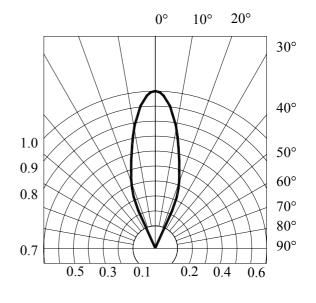


Typical Electrical / Optical Characteristics Curves:









FORWARD CURRENT VS. AMBIENT TEMPERATURE

RADIATION DIAGRAM

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Precautions:

TAKE NOTE OF THE FOLLOWING IN USE OF LED

1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130 .

At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

(2) Dip soldering:

Pre-heat: 90 max. (Backside of PCB), Within 60 seconds.

Solder bath: 260±5 (Solder temperature), Within 5 seconds.

(3) Hand soldering: 350 max. (Temperature of soldering iron tip), Within 3 seconds.

3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same.

4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120 max. Baking time: Within 60 seconds.

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

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ENCASED TYPE



LEDTECH ELECTRONICS CORP.

PART NO :LTXXXX-XX

Q'TY : PCS

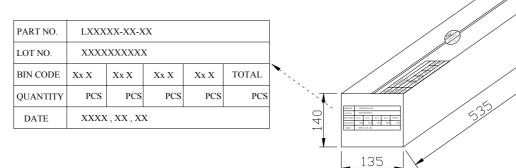
LOT NO :XXXXXXXXX

DATE : BIN CODE:



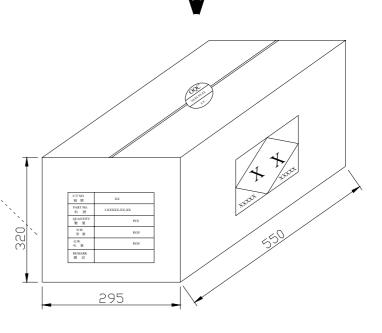
QUANTITY: 40 PACKETS

TOTAL: 8,000 PCS



OUTER CARTON QUANTITY: 4 BOX TOTAL: 32,000 PCS

C/T NO. 箱 號	XX
PART NO. 料 號	LXXXXX-XX-XX
QUANTITY 數 量	PCS
N.W. 净 重	KGS
G.W. 毛 重	KGS
REMARK 備 註	



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